

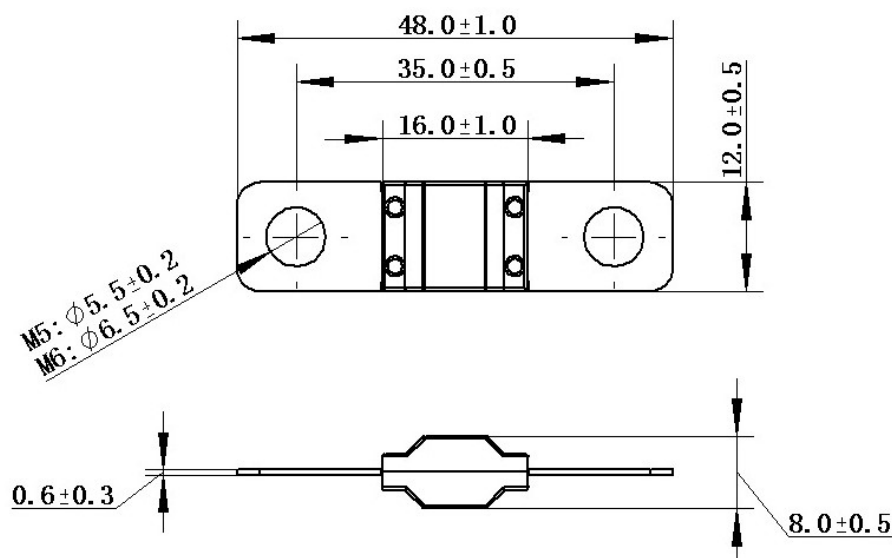
WCPF-35HV series (Rev: B)

HIGH CURRENT FUSE

■ Features

- Small size with high current rating for short circuit protection
- High breaking capacity under 100Vdc
- RoHS compliant and Lead Free
- 35mm pitch prevents mistaken replacement with other types of high-current fuses
- Operating Temperature: -40 to 125°C degrees

■ Product Dimensions and Recommended Land Pattern (mm)



Product Dimensions

Note: Dimensions in mm. Please refer to the outline drawing for dimensions and tolerances.

■ Electrical Characteristics

Part number	Current Rating	Voltage Rating	Breaking Capacity	Nominal Cold DCR	Nominal I^2t
	A			m Ω	A ² s
WCPF0050A-35HV	50	100V DC	3000A@100 V DC	0.92	1250
WCPF0060A-35HV	60			0.73	2230
WCPF0080A-35HV	80			0.51	5400
WCPF0100A-35HV	100			0.43	9600
WCPF0150A-35HV	150			0.33	21800
WCPF0200A-35HV	200			0.24	38500
WCPF0250A-35HV	250			0.19	60500
WCPF0300A-35HV	300			0.16	85000
WCPF0350A-35HV	350			0.13	92000

Note: The typical I^2t is an average value calculated from the breaking capacity tests by using the melting time before the arcing occurs.

■ Clear-Time Characteristics (Fast Acting)

% of current rating	Clear-time at 25℃	
100%	360000 sec (min)	-
300%	-	10 sec (max)

Note: Current recommendation may be impacted by the final condition of the application (terminals characteristics, wire size etc..).

■ Part Numbering

WC PF 0200A – 35HV

(1) (2) (3) (4)(5)

(1) Company code: Wayon Chip Fuse

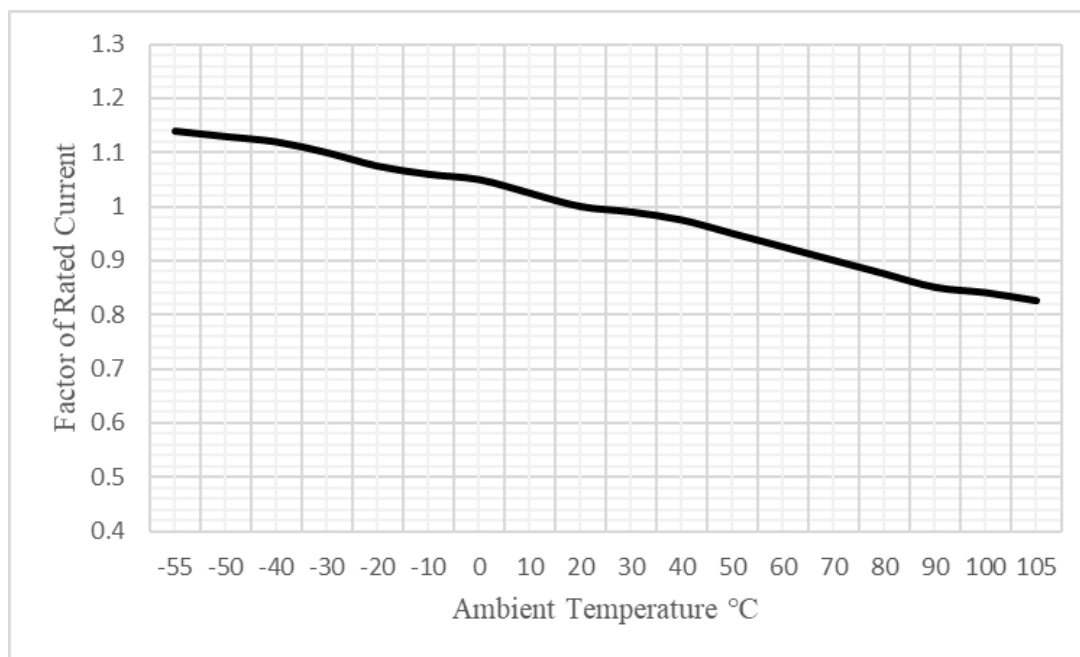
(2) Action code: F-Fast Acting, S-Slow Blow

(3) Current rating code: 0200A-200 A

(4) Pitch of screw holes: 35mm

(5) Supplementary Code: The default is empty, alphabet and number denoting customer code or package code.

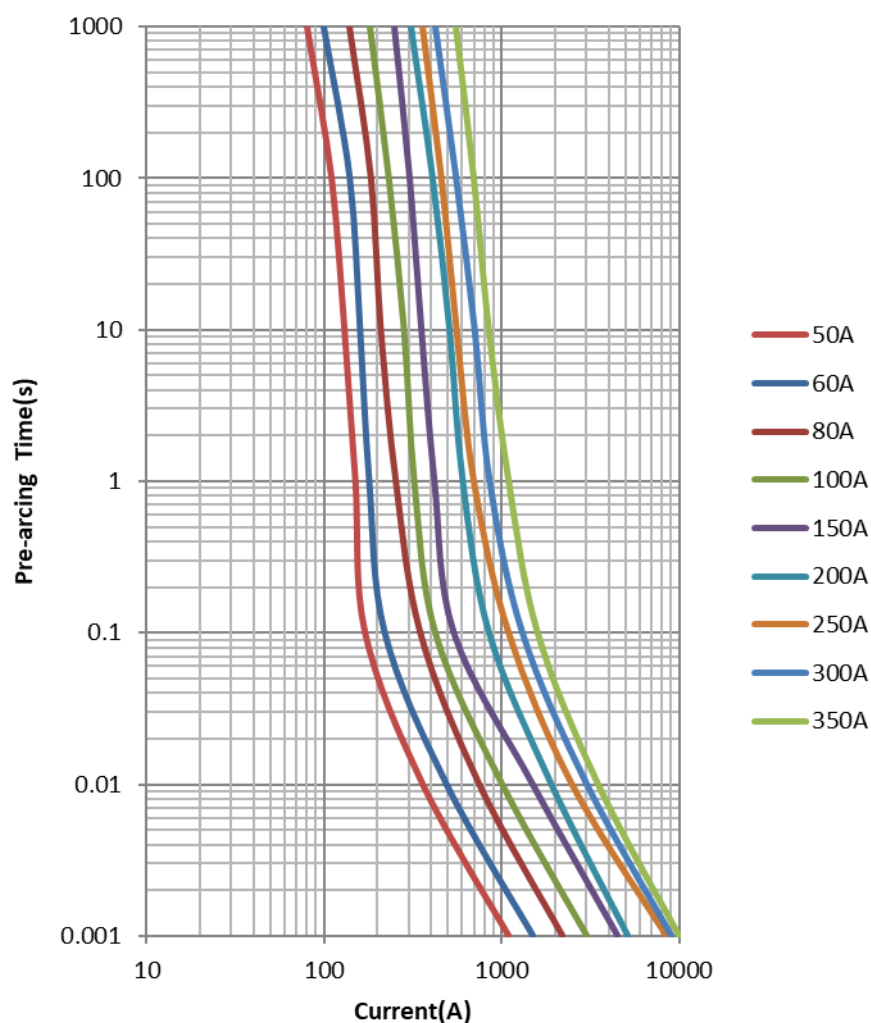
■ Temperature De-rating Guideline



Note: Current recommendation may be impacted by the final condition of the application (terminals characteristics, wire size etc..).

Curves

Average Clear-Time Curves



Note: Current recommendation may be impacted by the final condition of the application (terminals characteristics, wire size etc..).

Packaging and Storage

Storage condition:

Temperature 25, humidity 35%-65%.

Packaging Data

Minimum package for: 165 PCS.

■ Cautions and warnings

1、Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housings used for assembly with fuses have to be clean before mounting.
- During operation, the fuse's surface temperature can be very high (ICL). Ensure that adjacent components are placed at a sufficient distance from the fuse to allow for proper cooling of the fuses.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of the fuse. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of fuse surface during processing.

2、Operation

- Use fuses only within the specified operating temperature range.
- Environmental conditions must not harm the fuses. Use fuses only in normal atmospheric conditions.
- Contact of chip fuses with any liquids and solvents should be prevented. It must be ensured that no water enters the chip fuse (e.g. through plug terminals). For measurement purposes (checking the specified resistance vs. temperature), the component must not be immersed in water but in suitable liquids (e.g. Galden).
- Avoid dewing and condensation.

■ Notice

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